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Docket No.: XA-10098

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U.S. DEPARTMENT OF COMMERCE

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To the Director of the United States Patent	and ladellak Sinc	c. , rouse .ecord the attached original documents or copy thereof.
1. Name of conveying party(ies): NAKAJIMA, Tsutomu YOSHIDA, Keiichi		Name and address of receiving party(ies):     Name: Renesas Technology Corp.
		Address: 4-1, Marunouchi 2-chome
Additional names(s) of conveying party(ies)	Yes No	
3. Nature of conveyance:		
	erger	
☐ Security Agreement ☐ Cha	ange of Name	City: Chiyoda-ku State/Prov.: Tokyo
☐ Other		Country: Japan ZIP:
Execution Date: August 6 and August 20, 2004		Additional name(s) & address(es) ☐ Yes ☒ No
4. Application number(s) or patent numbers(s	s):	
If this document is being filed together with	ո a new application,	, the execution date of the application is:
Patent Application No. Filing date	,	B. Patent No.(s)
PCT/JP02/01845 28 February (assigned U.S. Appln. No. 10/503,619)	y 2002	
	Additional numbers	☐ Yes ☒ No
5. Name and address of party to whom correspondence concerning document should be mailed:  Name: Mitchell W. Shapiro  Registration No. 31,568  Address: Miles & Stockbridge P.C.  1751 Pinnacle Dr., Suite 500		6. Total number of applications and patents involved:
		7. Total fee (37 CFR 3.41):\$ 40.00
		Enclosed - Any excess or insufficiency should be credited or debited to deposit account
		☐ Authorized to be charged to deposit account
03/24/2005 LLANDGRA 00000075 10503619		8. Deposit account number:
02 FC:8021 40.00 OP		
City: McLean State/P	Prov.: VA	50-1165
Country: U.S. ZIP: 23	2102	(Attach duplicate copy of this page if paying by deposit account)
	DO NOT I	USE THIS SPACE
<ol> <li>Statement and signature.</li> <li>To the best of my knowledge and belief, th of the original document.</li> </ol>	ne foregoing informa	ation is true and correct and any attached copy is a true copy
Mitchell W. Shapiro	//M	March 18, 2005
Name of Person Signing	-	Signature / Date
Total numb	per of pages including co	over sheet, attachments, and

REEL: 016420 FRAME: 0016

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan,

a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## NONVOLATILE SEMICONDUCTOR STORAGE DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp..

Signed on the date(s) indicated aside our signatures:

RECORDED: 03/18/2005

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Sutomu Nakajima Tsutomu NAKAJIMA	6/August/2004
2)	seiichi Yoshida Keiichi YOSHIDA	20/August /2004
3)		
4)		
5)		
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7)		
8)		
9)		
10)		

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